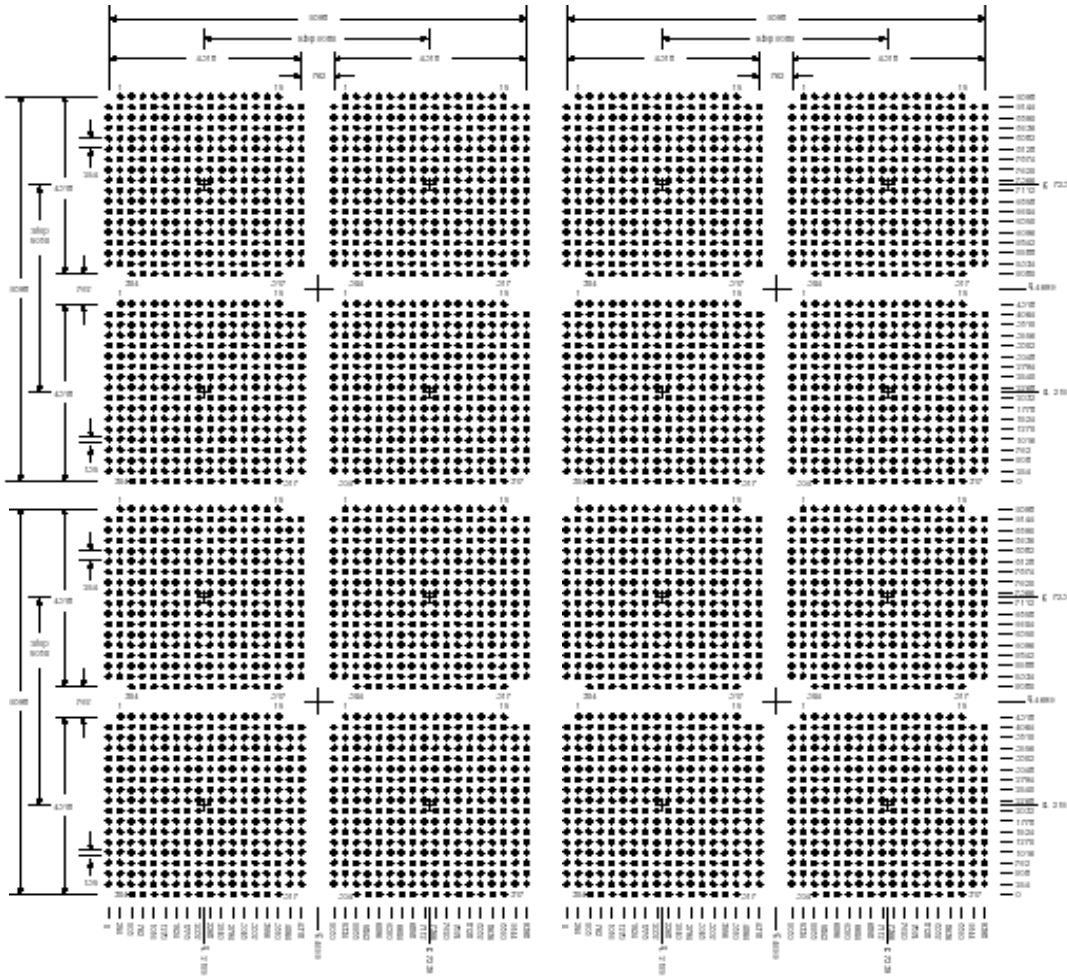


Step and Repeat X, Y is 5080um

16 Arrays of 317 Bumps



Bump Options (Part Number):

FC5072G20E254 = Sn63/Pb37

FC5072G20C254 = Sn/Ag/Cu (Pb Free)

Standard Packaging: 4 dies per tray (2" waffle pack)

TopLine Corporation

Toll Free USA/Canada (800) 776-9888

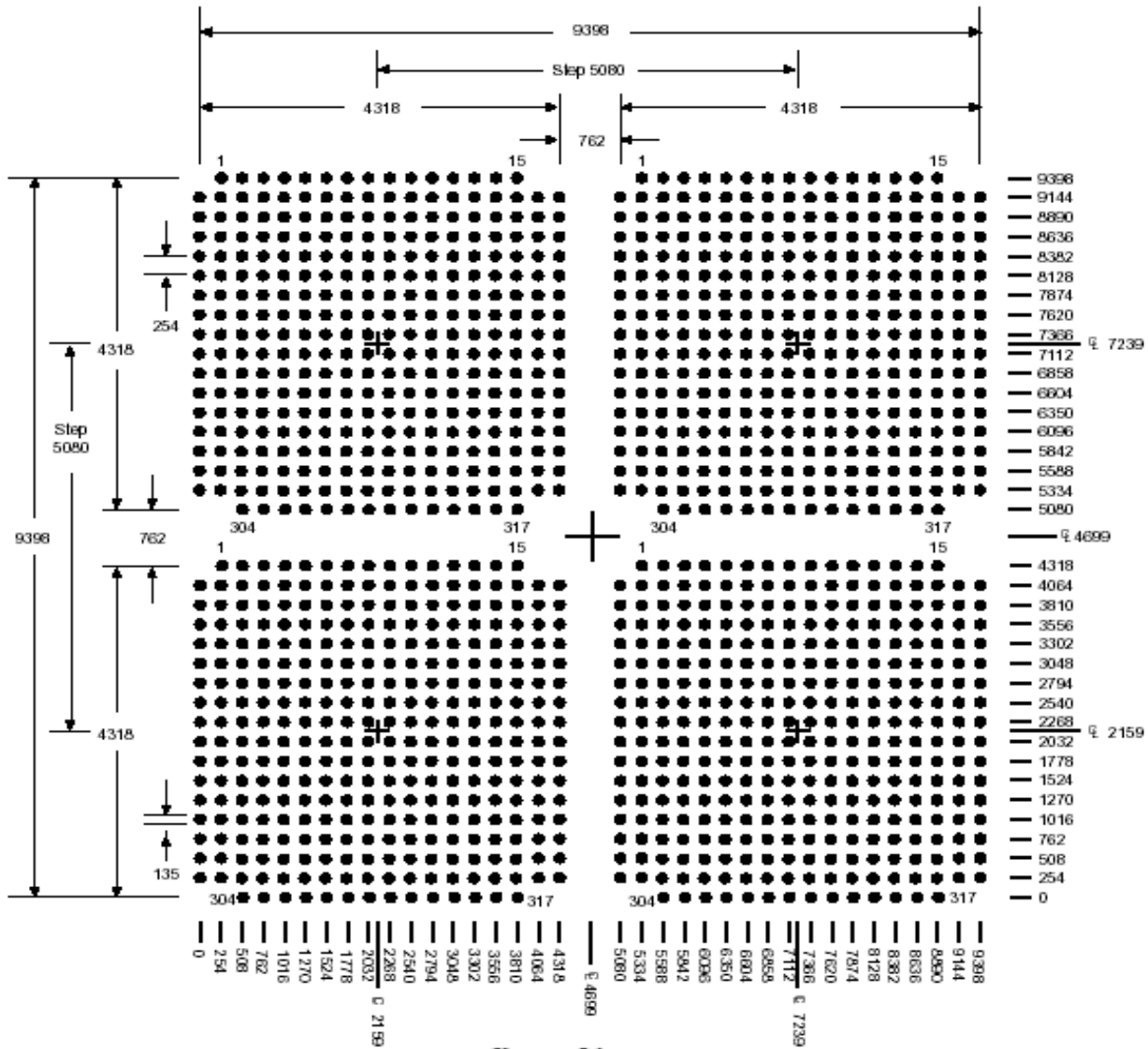
www.TopLine.tv

email: info@topline.tv



FC5072 Flip Chip

Step and Repeat 5080um



BUMP VIEW

Dimension in µm (1000µm = 1.0mm)

Bump Options (Part Number):

FC5072G20E254 = Sn63/Pb37

FC5072G20C254 = Sn/Ag/Cu (Pb Free)

Standard Packaging: 4 dies per tray (2" waffle pack)

TopLine Corporation

Toll Free USA/Canada (800) 776-9888

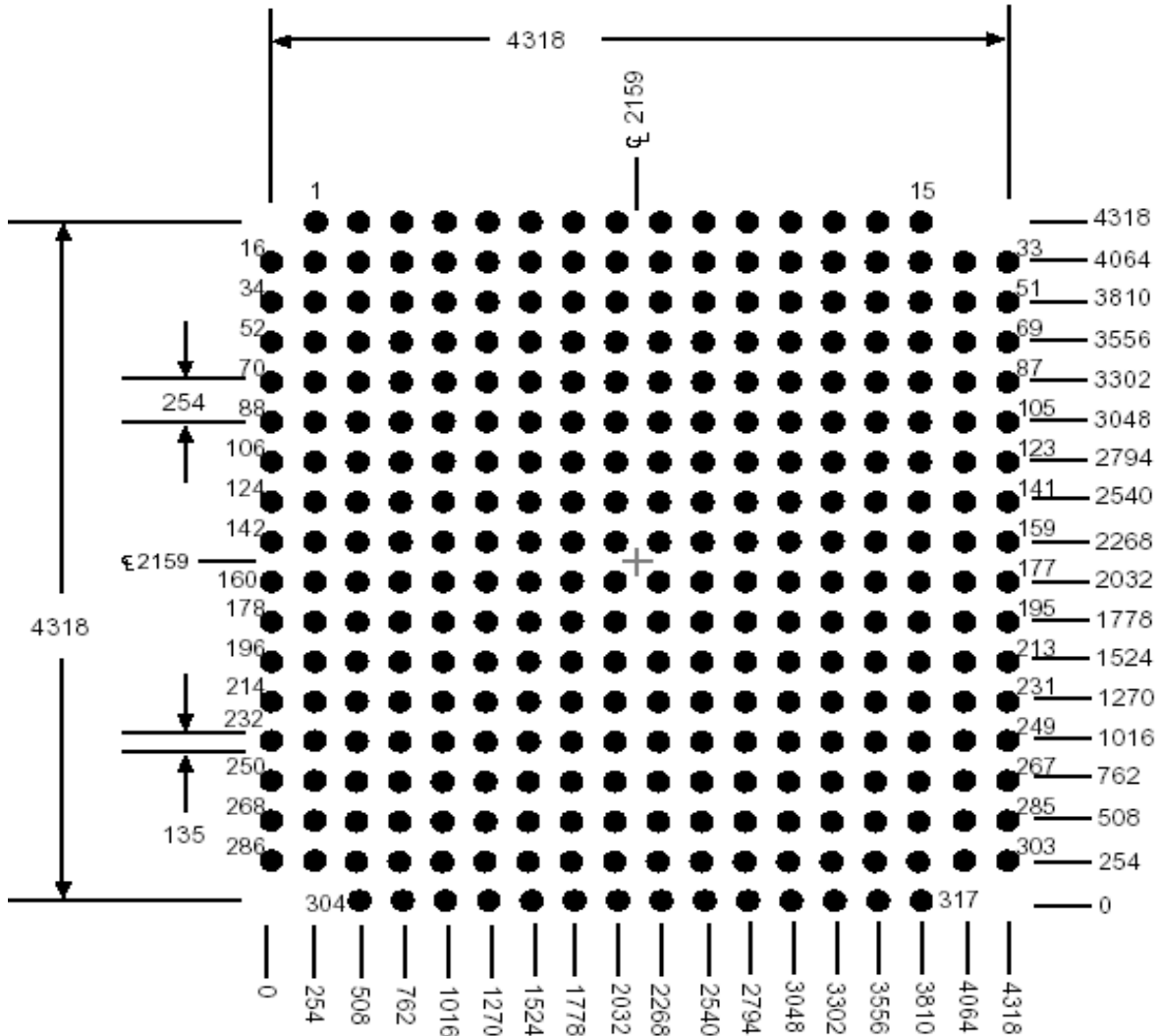
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email: info@topline.tv



FC5072 Flip Chip

Single Array (317 Bumps) Detail



Bump Options (Part Number):

FC5072G20E254 = Sn63/Pb37

FC5072G20C254 = Sn/Ag/Cu (Pb Free)

Standard Packaging: 4 dies per tray (2" waffle pack)

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